

电子与封装

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目 次

·封装、组装与测试·

一种陶瓷传输结构截止频率的分析方法	余希猛,杨振涛,刘林杰	110201
第三代半导体器件用高可靠性环氧塑封料的制备(封面文章)	王殿年,李泽亮,郭本东,段嘉伟	110202
FPGA 刷新控制电路测试方法的研究	晏慧强,黄晓彬,谢文虎	110203
封装设计中传输线损耗的理论计算	周立彦,汤文学,庞影影,王剑峰,王波	110204

·电路与系统·

12 GSa/s 12 bit 超宽带数据采集系统研究	许家玮,武锦,孔谋夫,周磊,季尔优	110301
抗辐射 LDO 单粒子效应的测控系统设计与实现	李欢,顾小明,徐晴昊	110302
一种具备 MBIST 功能的 Flash 型 FPGA 配置芯片设计	柯志鸣,党堃原,单宝琛,丛红艳	110303
基于 TIADC 的高速、高带宽信号采集系统	余国良,陆霄,李居强,孟祥冬,孙晓冬	110304
一种低功耗多模式 AB 类音频放大器的设计	徐凯英,丁宁,孔祥艺,黄立朝	110305
有源箝位反激式 DC-DC 变换器恒定谷值电流控制策略	管月,纪飞,汪渭滨	110306
Ku 波段 200 W GaN 功率放大器的设计与实现	苏鹏,顾黎明,唐世军,周书同	110307
一种改进型可配置逻辑块的结构设计	蔡宏瑞,范继聪,徐彦峰,陈波寅	110308

·材料、器件与工艺·

4H-SiC 基 FinFET 器件的单粒子瞬态效应研究	刘保军,杨晓阔,陈名华	110401
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·产品、应用与市场·

基于硬件角产生器的齿轮角度和转速测量设计	尚国庆,陶青平,刘满丽	110501
基于声音采集与分类技术的报警系统设计	徐婕,沈丹丹,潘硕,朱习松	110502

·封装前沿报道·

包镍碳纳米管提高烧结银的断裂韧性	代岩伟,昝智,秦飞	110601
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CONTENTS

·Packaging & Assembly & Testing·

Analysis Method of Cut-off Frequency of Ceramic Transmission Structure	YU Ximeng, YANG Zhentao, LIU Linjie	110201
Preparation of High Reliability Epoxy Molding Compound for Third Generation Semiconductor Devices (Cover Paper)	WANG Diannian, LI Zeliang, GUO Bendong, DUAN Jiawei	110202
Research on Test Method of FPGA Refresh Control Circuit	YAN Huiqiang, HUANG Xiaobin, XIE Wenhua	110203
Theoretical Calculation of Transmission Line Loss in Package Design	ZHOU Liyan, TANG Wenxue, PANG Yingying, WANG Jianfeng, WANG Bo	110204

·Circuit & System·

Research on 12 GSa/s 12 bit Ultra Wideband Data Acquisition System	XU Jiawei, WU Jin, KONG Moufu, ZHOU Lei, JI Eryou	110301
Design and Implementation of Measurement and Control System for Single Event Effect of Radiation Resistant LDO	LI Huan, GU Xiaoming, XU Qinghao	110302
Design of a Flash-Based FPGA Configuration Chip with MBIST Function	KE Zhiming, DANG Kunyuan, SHAN Baichen, CONG Hongyan	110303
High Speed and High Bandwidth Signal Acquisition System Based on TIADC	YU Guoliang, LU Xiao, LI Juqiang, MENG Xiangdong, SUN Xiaodong	110304
Design of a Low Power Multi-Mode Class AB Audio Amplifier	XU Kaiying, DING Ning, KONG Xiangyi, HUANG Lichao	110305
Constant Valley Current Control Strategy for Active Clamp Flyback DC-DC Converter	GUAN Yue, JI Fei, WANG Weibin	110306
Design and Implementation of 200 W GaN Power Amplifier in Ku-Band	SU Peng, GU Liming, TANG Shijun, ZHOU Shutong	110307
Structural Design of an Improved Configurable Logic Block	CAI Hongrui, FAN Jicong, XU Yanfeng, CHEN Boyin	110308

·Materials & Devices & Processes·

Research on Single Event Transient Effect of 4H-SiC Based FinFET Device	LIU Baojun, YANG Xiaokuo, CHEN Minghua	110401
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·Products & Applications·

Design of Gear Angle and Speed Measurement Based on Hardware Angle Generator	SHANG Guoqing, TAO Qingping, LIU Manli	110501
Alarm System Design Based on Sound Acquisition and Classification Technology	XU Jie, SHEN Dandan, PAN Shuo, ZHU Xisong	110502

·Packaging Frontiers Report·

Enhancement of the Fracture Toughness of Sintered Silver by Ni Coated Carbon Nanotubes	DAI Yanwei, ZAN Zhi, QIN Fei	110601
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